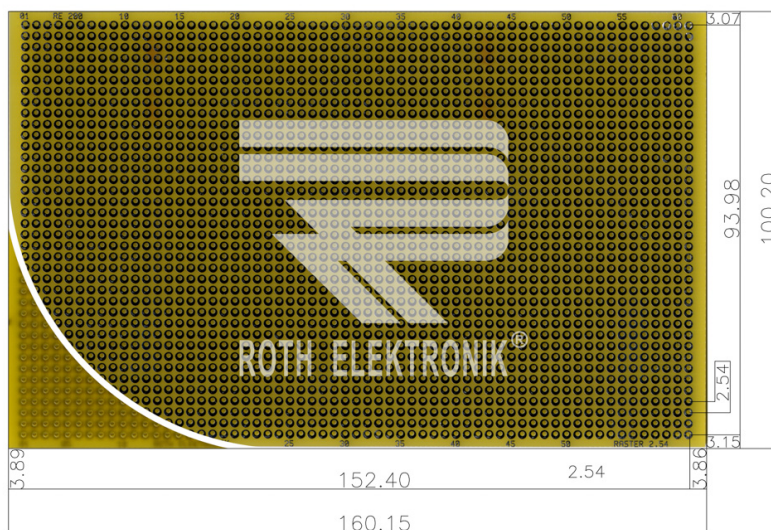




RE200-LF

- Epoxy fibre-glass FR4 1.50 mm
- Single-sided 35 µm Cu
- Hot air leveling (HAL-leadfree)
- Hole spacing 2.54 x 2.54 mm
- 38 x 61 soldering pads 2.20 mm Ø
- Hole diameter 1.00 mm
- Size 100 x 160 mm